IGBT with Monolithic Free Wheeling Diode

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop (FS) Trench construction, and provides superior performance in demanding switching applications, offering both low on–state voltage and minimal switching loss. The IGBT is well suited for resonant or soft switching applications.

Features

- Extremely Efficient Trench with Fieldstop Technology
- Low Switching Loss Reduces System Power Dissipation
- Optimized for Low Losses in IH Cooker Application
- Reliable and Cost Effective Single Die Solution
- This is a Pb–Free Device

Typical Applications

- Inductive Heating
- Consumer Appliances
- Soft Switching

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-emitter voltage	V _{CES}	1200	V
Collector current @ Tc = 25°C @ Tc = 100°C	Ι _C	80 40	A
Pulsed collector current, T_{pulse} limited by T_{Jmax} , 10 μ s pulse, V_{GE} = 15 V	I _{CM}	120	A
Diode forward current @ Tc = 25°C @ Tc = 100°C	l _F	80 40	A
Diode pulsed current, T_{pulse} limited by T_{Jmax} , 10 µs pulse, $V_{GE} = 0 V$	I _{FM}	120	A
Gate-emitter voltage Transient Gate-emitter voltage (T _{pulse} = 5 μs, D < 0.10)	V _{GE}	±20 ±25	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P _D	384 192	W
Operating junction temperature range	TJ	-40 to +175	°C
Storage temperature range	T _{stg}	–55 to +175	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C

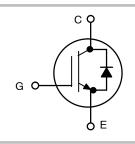
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

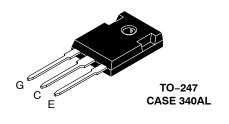


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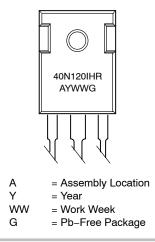
http://onsemi.com

40 A, 1200 V V_{CEsat} = 2.30 V E_{off} = 0.95 mJ





MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
NGTB40N120IHRWG	TO–247 (Pb–Free)	30 Units / Rail

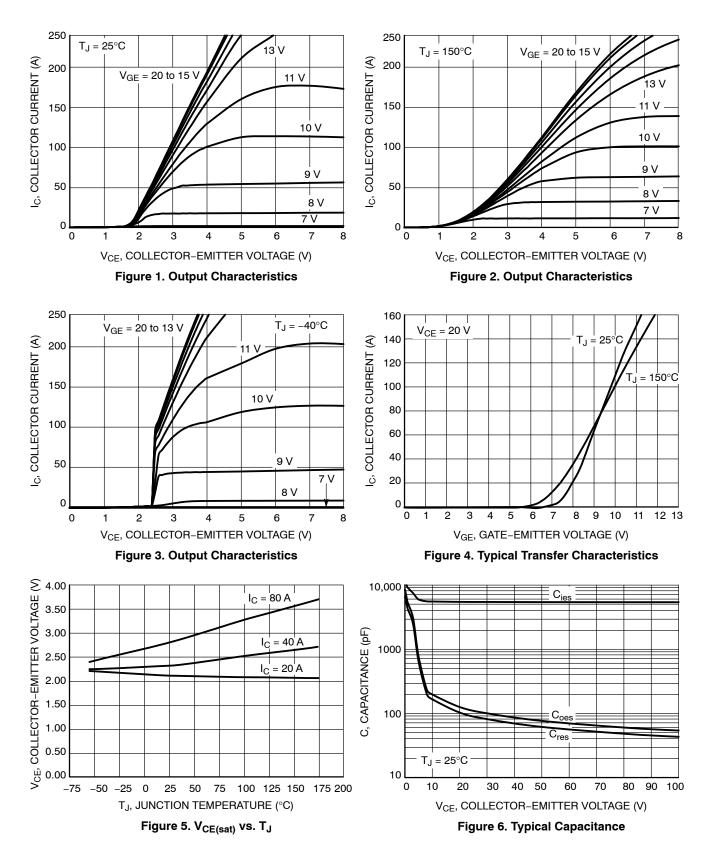
THERMAL CHARACTERISTICS

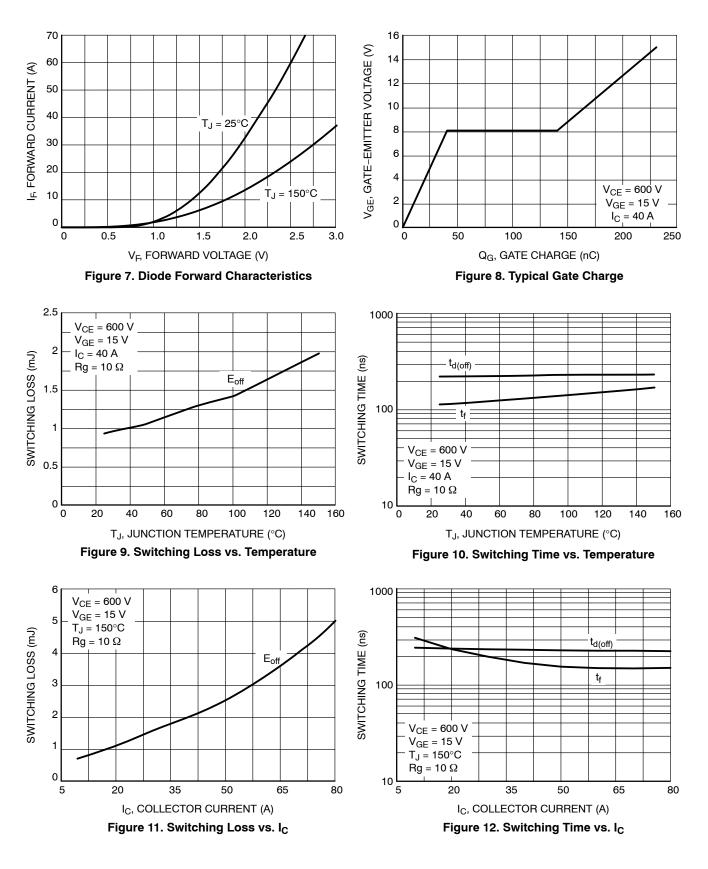
Rating	Symbol	Value	Unit
Thermal resistance junction-to-case	$R_{ ext{ heta}JC}$	0.39	°C/W
Thermal resistance junction-to-ambient	$R_{\theta JA}$	40	°C/W

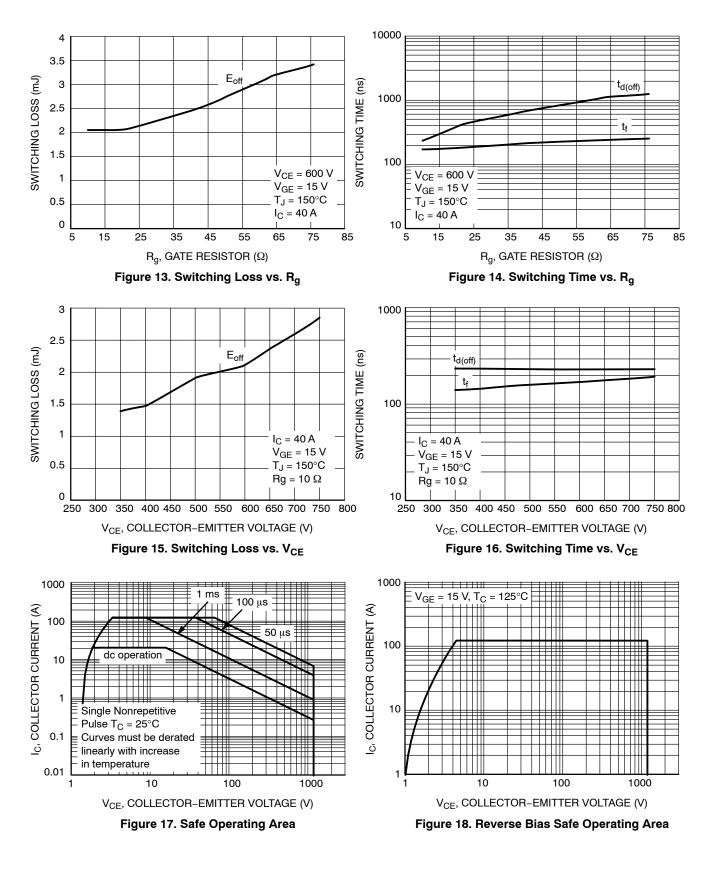
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC	•	•				
Collector-emitter breakdown voltage, gate-emitter short-circuited	V_{GE} = 0 V, I _C = 500 μ A	V _{(BR)CES}	1200	_	-	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 40 A V _{GE} = 15 V, I _C = 40 A, T _J = 175°C	V _{CEsat}	-	2.30 2.70	2.55 -	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_C = 250 \ \mu A$	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	$V_{GE} = 0 V, V_{CE} = 1200 V$ $V_{GE} = 0 V, V_{CE} = 1200 V, T_{J=} 175^{\circ}C$	I _{CES}			0.2 2.8	mA
Gate leakage current, collector-emitter short-circuited	V_{GE} = 20 V, V_{CE} = 0 V	I _{GES}	_	-	100	nA
DYNAMIC CHARACTERISTIC	·					
Input capacitance		C _{ies}	-	5320	_	pF
Output capacitance	V_{CE} = 20 V, V_{GE} = 0 V, f = 1 MHz	C _{oes}	-	124	-	
Reverse transfer capacitance		C _{res}	-	100	-	
Gate charge total		Qg	-	225	-	nC
Gate to emitter charge	V_{CE} = 600 V, I _C = 40 A, V _{GE} = 15 V	Q _{ge}	-	36	-	
Gate to collector charge		Q _{gc}	-	98	-	
SWITCHING CHARACTERISTIC, INDUC						
Turn-off delay time	$T_{\rm J} = 25^{\circ} \rm C$	t _{d(off)}	-	230	-	ns
Fall time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 40 \text{ A}$ $R_{a} = 10 \Omega$	t _f	-	120	-	
Turn-off switching loss	V _{GE} = 0 V/ 15V	E _{off}	-	0.95	-	mJ
Turn-off delay time	T _J = 150°C	t _{d(off)}	-	245	-	ns
Fall time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 40 \text{ A}$ $\text{R}_{g} = 10 \Omega$	t _f	-	180	-	
Turn-off switching loss	V _{GE} = 0 V/ 15V	E _{off}	-	2.10	-	mJ
DIODE CHARACTERISTIC						
Forward voltage	V _{GE} = 0 V, I _F = 40 A V _{GE} = 0 V, I _F = 40 A, T _J = 175°C	V _F	-	2.10 3.30	2.60	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.







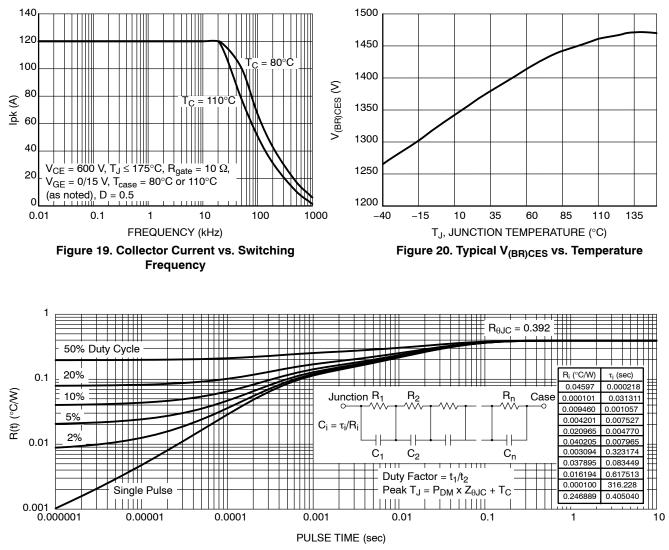


Figure 21. IGBT Transient Thermal Impedance

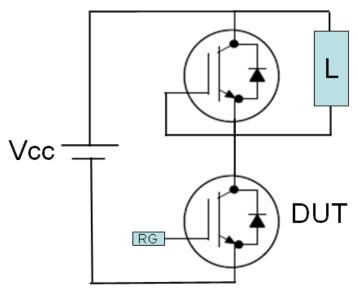
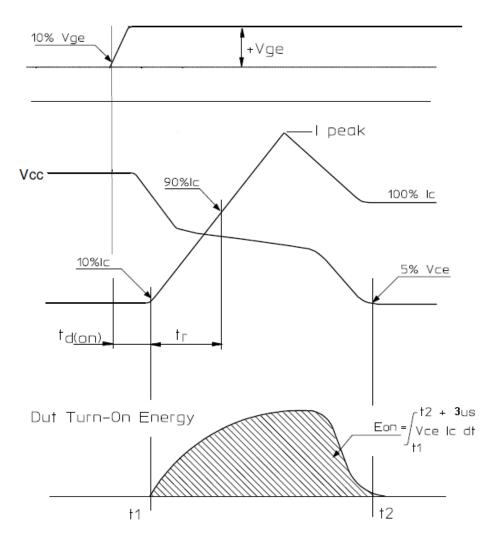
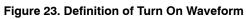
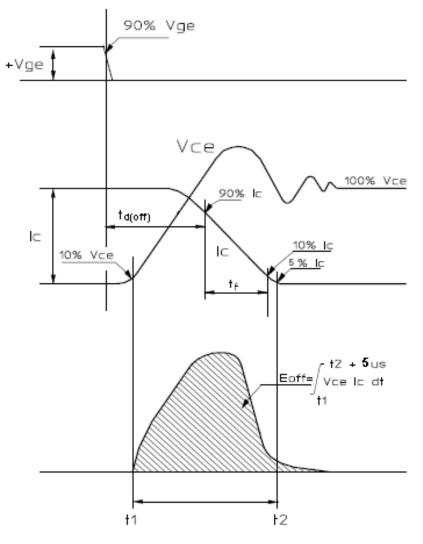
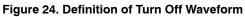


Figure 22. Test Circuit for Switching Characteristics

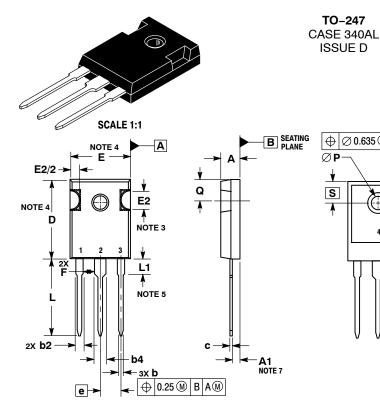








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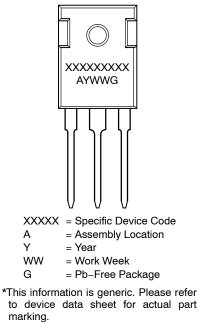
DATE 17 MAR 2017

NOTES

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS. SLOT REQUIRED, NOTCH MAY BE ROUNDED. 1
- 2. 3.
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.13 PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREME OF THE PLASTIC BODY.
- LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY 5.
- L1. 6.
- ⊘P SHALL HAVE A MAXIMUM DRAFT ANGLE OF 1.5° TO THE TOP OF THE PART WITH A MAXIMUM DIAMETER OF 3.91.
- 7. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED

BY L1.			
	MILLIMETERS		
DIM	MIN	MAX	
Α	4.70	5.30	
A1	2.20	2.60	
b	1.07	1.33	
b2	1.65	2.35	
b4	2.60	3.40	
C	0.45	0.68	
D	20.80	21.34	
Е	15.50	16.25	
E2	4.32	5.49	
е	5.45 BSC		
F	2.655		
L	19.80	20.80	
L1	3.81	4.32	
Ρ	3.55	3.65	
Q	5.40	6.20	
S	6.15 BSC		

GENERIC **MARKING DIAGRAM***



Pb-Free indicator, "G" or microdot " .", may or may not be present.

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